Docket No .:

As a below named inventor, I hereby declare that:



DECEMBER TOWN AND TOWN OF ATTORNEY

My residence, post office and citizen	ship are as stated below	next to my name,	
names are listed below) of the subjec	t matter claimed and for OF USER RELEVANCE	which a patent is sought on th FEEDBACK AND METHOD (original, first and joint inventor (if plural the invention entitled MULTIMEDIA DATA OF DETERMINING WEIGHTS OF IMAGE
[X] is attached hereto [] was f amended on	iled on	as Application Serial No (if applicable)	and was
I hereby state that I have reviewed an by any amendment referred to above		ts of the above identified spec	ification, including the claims, as amended
I acknowledge the duty to disclose in of Federal Regulations, Section 1.56(vn to me to be material to pate	entability in accordance with Title 37, Code
certificate, or 365(a) of any PCT inte	rnational application wh below, by checking the l	ich designated at least one coupox, any foreign application for	gn application(s) for patent or inventor's intry other than the United States of Americ or patent or inventor's certificate, or of any riority is claimed.
Prior F reign Application(s):			oreign Filing Date
<u>¹Number</u> ²	Country	<u>M</u>	Ionth/Day/Year
41138/1999	Republic of Korea		September 22, 1999
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TO 1			
르 <u>.</u>			
I hereby claim the benefit under 35 U			on(s) listed below.
***Application Number(s):	Filing 1	Date(Month/Day/Year)	
designating the United States of Ame disclosed in the prior United States o	rica, listed below and, ir r PCT international appli formation which is mate	asofar as the subject matter of ication in the manner provided rial to patentability as defined	5(c) of any PCT international application each of the claims of this application is not by the first paragraph of 35 U. S. C. 112, I in 37 CFR 1.56 which became available date of this application.
Prior U.S. Application			
or PCT Parent Number	Filing Date(Mo	nth/Day/Year)	Parent Patent Number (if applicable)
			
I hereby declare that all statements m	ade herein of my own ki	nowledge are true and that all	statements made on information and belief

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so ma are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney (5), Ind/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vasquez, Registration No. 38,647; Stuart I. Smith, Registration No. 42,159; Carol L. Druzbick, Registration No. 40,287; Anthony H.Nourse, Registration No. 46,121; and Margaret A. Burke, Registration No. 34,474, all of

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them. Full name of sole or first inventor: Jin Soo LEE Date: 09//8/00 Inventor's signature: Residence: Seoul, Korea Citizenship: Republic of Korea Post Office Address: Samick APT 101-804, 573, Macheon2-dong, Songpa-gu, Seoul, Korea Full name of joint inventor(s): Hyeon Jun KIM Tinventor's signature: Residence: Kyounggi-do, Korea Citizenship: Republic of Korea Post Office Address: Hansin-life 109-302, Boondang-dong, Boondang-gu, Seongnam-si, Kyounggi-do, Korea Full name of joint inventor(s): Hee Youn LEE Inventor's signature: - Residence: Seoul, Korea Citizenship: Republic of Korea Post Office Address: Sanga APT 2-609, Samsung-dong, Kangnam-gu, Seoul, Korea Full name of joint inventor(s): Inventor's signature: Date: Residence: Citizenship: Post Office Address: Full name of joint inventor(s): Inventor's signature: Date: Residence: Citizenship:

Post Office Address: